



SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- Low Reverse Leakage Current
- Ideal for Battery Powered Portable Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Marking Information
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 e4
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

Ordering Information (Note 4)

	Part Number	Case	Packaging	
	1N4448HLP-7	X1-DFN1006-2	3,000/Tape & Reel	
1N4448HLP-7B		X1-DFN1006-2	10,000/Tape & Reel	
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.				

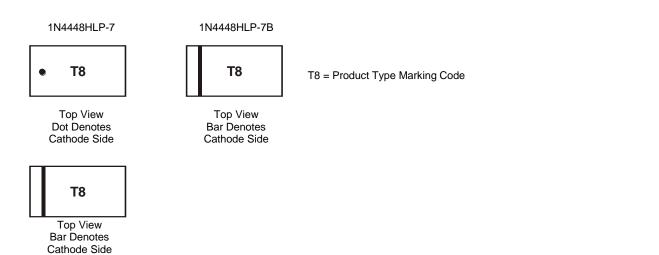
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimonyfree, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information (Note 5)



5. From date code 1527 (YYWW), dot marking was changed to bar marking for 1N4448HLP-7. Note:



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current		I _{FM}	300	mA
Average Rectified Output Current		lo	95	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I _{FSM}	2.0 1.0	A

Thermal Characteristics

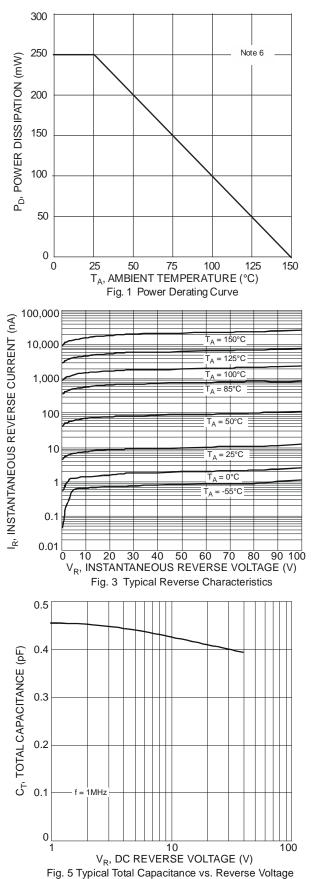
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance Junction to Ambient (Note 6)	$R_{ ext{ heta}JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	С°С

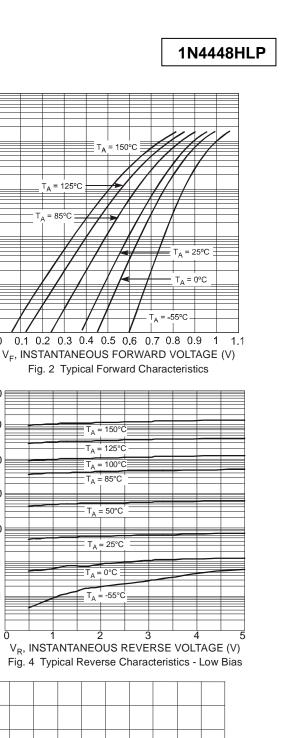
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Conditions	
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	80		V	I _R = 100μA	
	V _F	0.62	0.72	V	I _F = 5.0mA	
Forward Voltage		—	0.855		I _F = 10mA	
Tolward Voltage		_	1.0		I _F = 100mA	
		_	1.25		I _F = 150mA	
	I _R		100	nA	V _R = 80V	
Deals Bayerea Current (Note 7)			50	μA	V _R = 75V, T _J = +150°C	
Peak Reverse Current (Note 7)		IR —		30	μA	V _R = 25V, T _J = +150°C
			25	nA	$V_R = 20V$	
Total Capacitance	Ст		3.0	pF	V _R = 0.5V, f = 1.0MHz	
Reverse Recovery Time		_	4.0	ns	$I_F = I_R = 10 \text{mA},$	
Reverse Recovery Time	t _{rr}				$I_{rr} = 0.1 \text{ x } I_R, R_L = 100\Omega$	

Notes: 6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. 7. Short duration pulse test used to minimize self-heating effect.







1,000

100

10

1

0.1

0.01

100,000

10,000

1,000

100

10

1

0.1

0.01

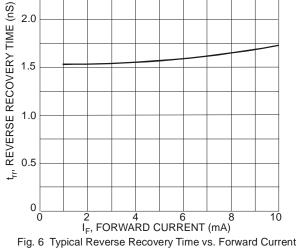
2.5

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I_R, INSTANTANEOUS REVERSE CURRENT (nA)

0

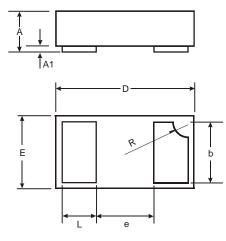
I_F, INSTANTANEOUS FORWARD CURRENT (mA)





Package Outline Dimensions

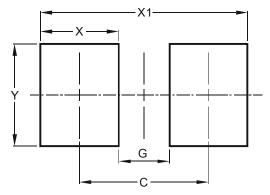
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
E	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Y	0.70



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